IGBT with Monolithic Free **Wheeling Diode**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

Features

- Extremely Efficient Trench with Fieldstop Technology
- 1350 V Breakdown Voltage
- Optimized for Low Losses in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- These are Pb-Free Devices

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---|-------------|------|
| Collector-emitter voltage | tor-emitter voltage V _{CES} 13 | | V |
| Collector current @ Tc = 25°C @ Tc = 100°C | I _C | 80 40 | Α |
| Pulsed collector current, T_{pulse} limited by T_{Jmax} , 10 μs Pulse, V_{GE} = 15 V | I _{CM} | 120 | Α |
| Diode forward current @ Tc = 25°C @ Tc = 100°C | I _F | 80 40 | Α |
| Diode pulsed current, T_{pulse} limited by T_{Jmax} , 10 μs Pulse, V_{GE} = 0 V | I _{FM} | 120 | Α |
| Gate-emitter voltage Transient Gate-emitter Voltage $(T_{pulse} = 5 \mu s, D < 0.10)$ | V_{GE} | ±20 ±25 | V |
| Power Dissipation @ Tc = 25°C @ Tc = 100°C | P _D | 394 197 | W |
| Operating junction temperature range | T _J | -40 to +175 | °C |
| Storage temperature range | T _{stg} | -55 to +175 | °C |
| Lead temperature for soldering, 1/8" from case for 5 seconds | T _{SLD} | 260 | °C |

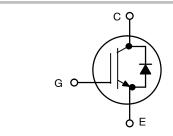
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

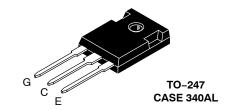


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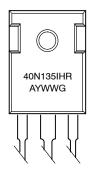
http://onsemi.com

40 A, 1350 V **V_{CEsat}** = 2.40 V $E_{off} = 1.30 \text{ mJ}$





MARKING DIAGRAM



= Assembly Location

= Year WW = Work Week = Pb-Free Package

ORDERING INFORMATION

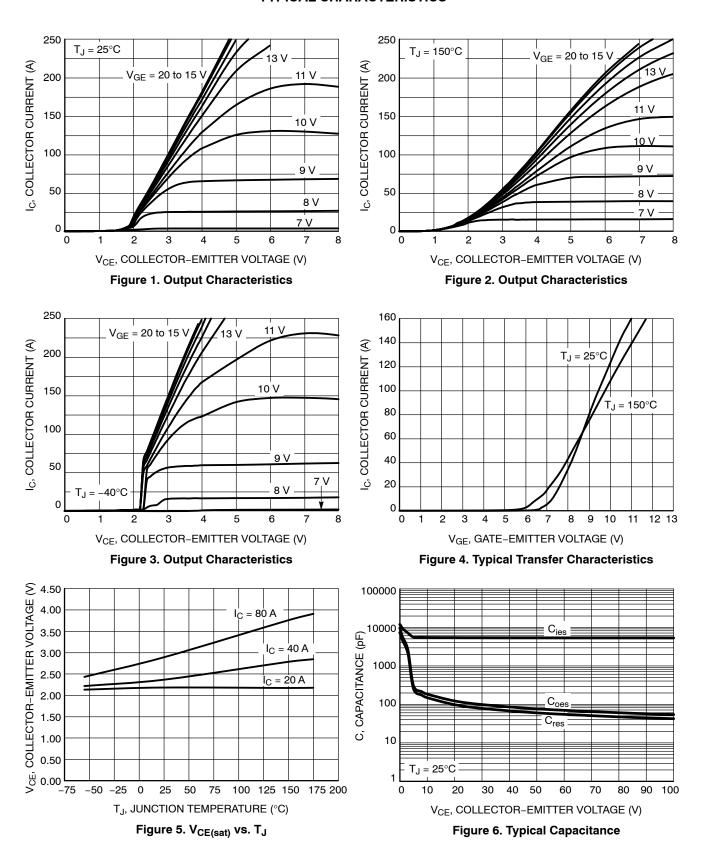
| Device | Package | Shipping |
|-----------------|---------------------|-----------------|
| NGTB40N135IHRWG | TO-247 (Pb-Free) | 30 Units / Rail |

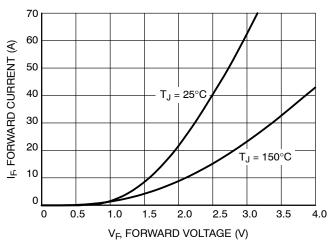
THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|----------------|-------|------|
| Thermal resistance junction-to-case | $R_{	heta JC}$ | 0.385 | °C/W |
| Thermal resistance junction-to-ambient | $R_{	heta JA}$ | 40 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|---|--|---------------------|--------|--------------|------------|------|
| STATIC CHARACTERISTIC | | | | | - | |
| Collector-emitter breakdown voltage, gate-emitter short-circuited | $V_{GE} = 0 \text{ V, I}_{C} = 500 \mu\text{A}$ $V_{(BR)CES}$ | | 1350 | _ | _ | V |
| Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C | V _{CEsat} | - - | 2.40 2.80 | 2.70 - | V |
| Gate-emitter threshold voltage | $V_{GE} = V_{CE}, I_{C} = 250 \mu A$ | V _{GE(th)} | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gate- emitter short-circuited | V _{GE} = 0 V, V _{CE} = 1350 V V _{GE} = 0 V, V _{CE} = 1350 V, T _{J =} 175°C | I _{CES} | - - | - - | 0.5 2.0 | mA |
| Gate leakage current, collector-emitter short-circuited | V _{GE} = 20 V, V _{CE} = 0 V | I _{GES} | - | - | 100 | nA |
| DYNAMIC CHARACTERISTIC | | • | | | | |
| Input capacitance | | C _{ies} | - | 5290 | _ | pF |
| Output capacitance | V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz | C _{oes} | - | 124 | _ | |
| Reverse transfer capacitance | | C _{res} | - | 100 | _ | |
| Gate charge total | | Q_g | - | 234 | - | nC |
| Gate to emitter charge | V_{CE} = 600 V, I_{C} = 40 A, V_{GE} = 15 V | Q _{ge} | - | 39 | _ | |
| Gate to collector charge | | Q _{gc} | - | 105 | - | |
| SWITCHING CHARACTERISTIC, INDUCT | TIVE LOAD | | | | | |
| Turn-off delay time | T _J = 25°C | t _{d(off)} | - | 250 | _ | ns |
| Fall time | $V_{CC} = 600 \text{ V}, I_{C} = 40 \text{ A}$ $R_{\alpha} = 10 \Omega$ | t _f | - | 130 | _ | |
| Turn-off switching loss | V _{GE} = 0 V/ 15 V | E _{off} | - | 1.30 | _ | mJ |
| Turn-off delay time | T _J = 150°C | t _{d(off)} | - | 260 | _ | ns |
| Fall time | V_{CC} = 600 V, I_{C} = 40 A R_{q} = 10 Ω | t _f | - | 190 | _ | |
| Turn-off switching loss | V _{GE} = 0 V/ 15 V | E _{off} | - | 2.60 | _ | mJ |
| DIODE CHARACTERISTIC | | | | | | |
| Forward voltage | $V_{GE} = 0 \text{ V, I}_{F} = 40 \text{ A}$ $V_{GE} = 0 \text{ V, I}_{F} = 40 \text{ A, T}_{J} = 175^{\circ}\text{C}$ | V _F | _ _ | 2.30 3.70 | 2.70 – | V |

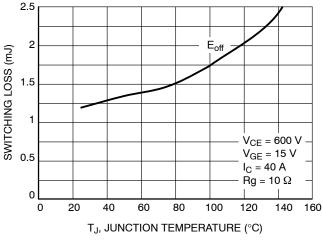




16 V_{GE}, GATE-EMITTER VOLTAGE (V) 14 12 10 6 V_{CE} = 600 V 2 V_{GE} = 15 V $I_{C} = 40 \text{ A}$ 0 0 50 100 150 200 250 Q_G, GATE CHARGE (nC)

Figure 7. Diode Forward Characteristics

Figure 8. Typical Gate Charge



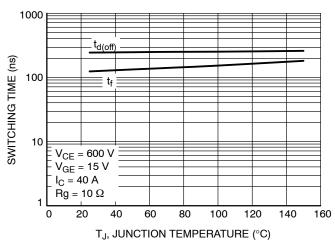
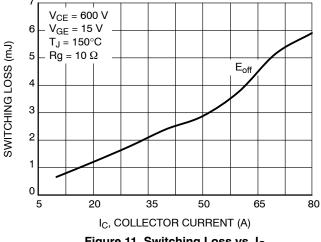


Figure 9. Switching Loss vs. Temperature

Figure 10. Switching Time vs. Temperature



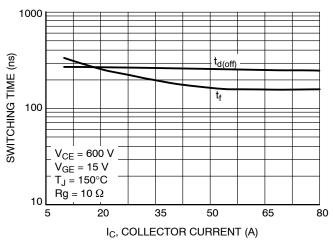
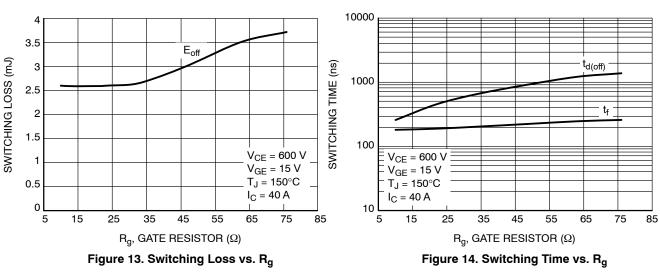


Figure 11. Switching Loss vs. I_C

Figure 12. Switching Time vs. I_C



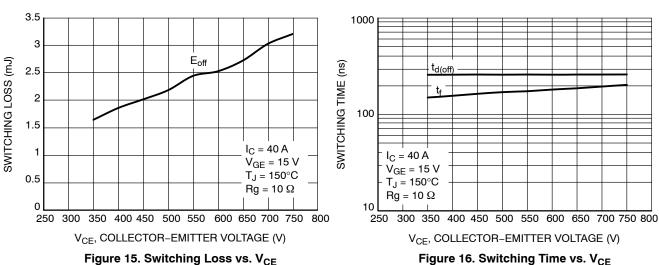


Figure 15. Switching Loss vs. V_{CE}

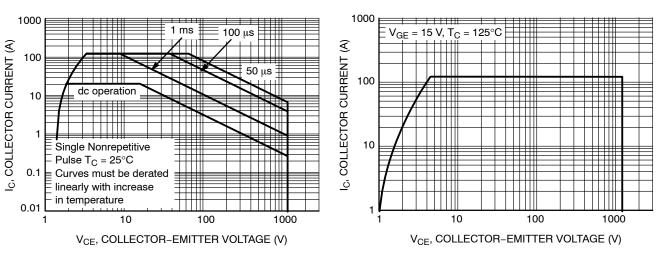


Figure 17. Safe Operating Area

Figure 18. Reverse Bias Safe Operating Area

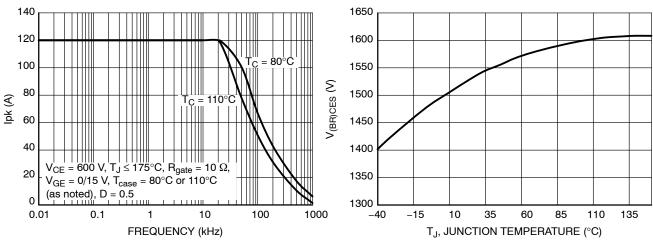


Figure 19. Collector Current vs. Switching Frequency

Figure 20. Typical $V_{(BR)CES}$ vs. Temperature

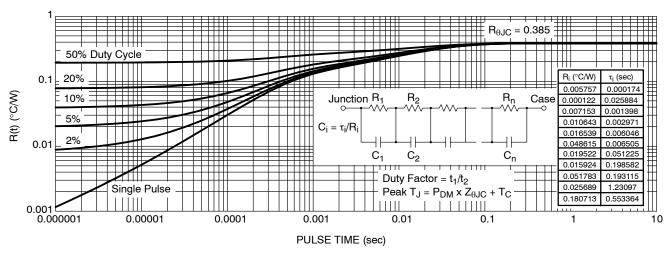


Figure 21. IGBT Transient Thermal Impedance

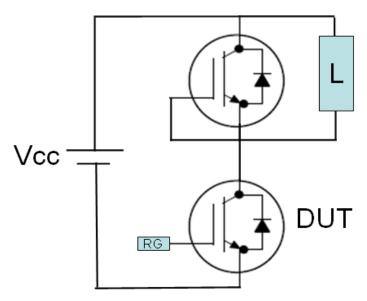


Figure 22. Test Circuit for Switching Characteristics

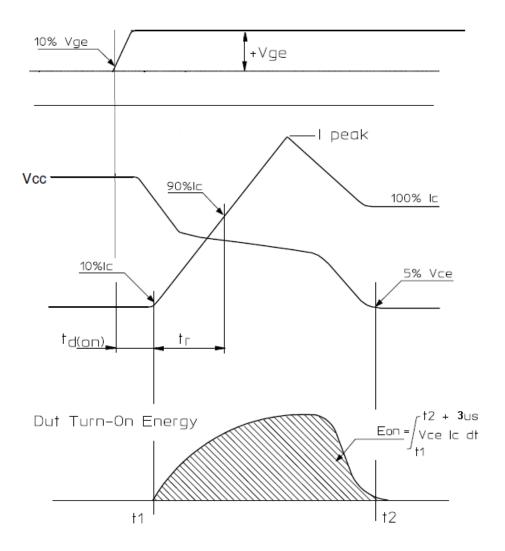


Figure 23. Definition of Turn On Waveform

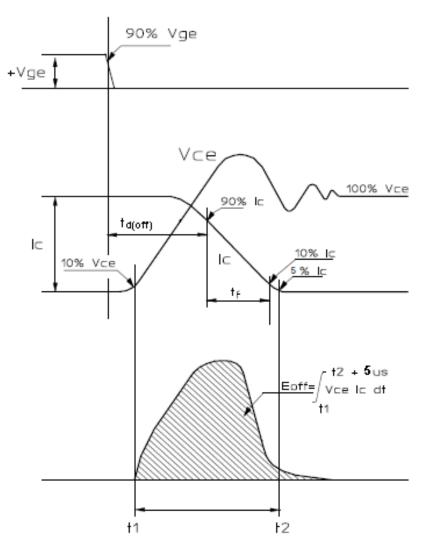
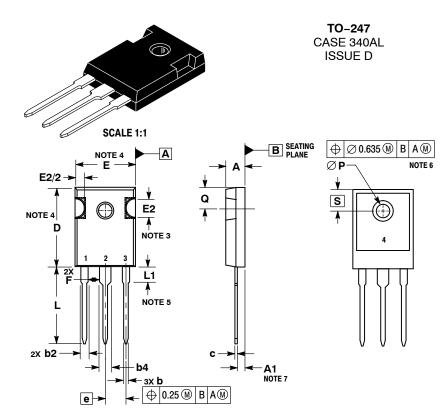


Figure 24. Definition of Turn Off Waveform



DATE 17 MAR 2017

- NOTES:

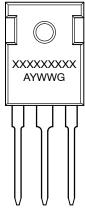
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.

 - DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH.
 MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY
- ©P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.

 DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED

| | MILLIMETERS | | |
|-----|-------------|-------|--|
| DIM | MIN MAX | | |
| Α | 4.70 | 5.30 | |
| A1 | 2.20 | 2.60 | |
| b | 1.07 | 1.33 | |
| b2 | 1.65 | 2.35 | |
| b4 | 2.60 | 3.40 | |
| С | 0.45 | 0.68 | |
| D | 20.80 | 21.34 | |
| E | 15.50 | 16.25 | |
| E2 | 4.32 | 5.49 | |
| е | 5.45 BSC | | |
| F | 2.655 | | |
| L | 19.80 | 20.80 | |
| L1 | 3.81 | 4.32 | |
| P | 3.55 | 3.65 | |
| Q | 5.40 6.20 | | |
| S | 6.15 BSC | | |

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code Α = Assembly Location

Υ = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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 IHW20N65R5XKSA1
 IDW40E65D2FKSA1